

# ECTC 2012

The 62nd Electronic Components and Technology Conference

## Thank you for attending the 62nd ECTC!

I would like to thank all authors, presenters, program committee members, exhibitors, sponsors, volunteers and all attendees for making the 62nd ECTC such a well-attended success.

Here are some conference statistics:

- Over 1,200 attendees, the second highest attendance ever, from 25 countries
- 348 technical papers presented in 36 oral and five interactive poster sessions, including a student poster session
- Over 63 papers/posters presented on 3D/TSV, including the best attended sessions of the conference
- 16 professional development courses attended by over 300 participants
- 83 Technical Corner exhibitors - a record!

In addition to the regular daytime sessions and courses, we offered three night seminars that were very well attended and a special morning session on the changing packaging foundry model.

- **ECTC Panel Discussion**  
Co-chaired by Rolf Aschenbrenner of Fraunhofer IZM and Ricky Lee of the Hong Kong University of Science and Technology and this year's CPMT President on the booming market in Power Electronics.
- **ECTC Plenary Discussion**  
Chaired by Christopher Bowers of Sempruis on the expanding markets and emerging technologies of Photonics.
- **Special Session**  
Chaired by Raj Pendse of STATS ChipPAC on the changing role of the Packaging Foundry.

Finally, the ECTC Keynote Speaker, Gregg Bartlett from GLOBALFOUNDRIES, brought the Foundry perspective to our attendees, helping us understand the challenges faced in continuing to scale digital technologies and keep up with memory bandwidth and power demands of future silicon nodes.

I would like to thank our corporate sponsors – particularly our Gala sponsors: Nanium and GLOBALFOUNDRIES, Amkor, Murata and Microsoft, and our Luncheon and Program sponsors: ASE, AMAT and Corning.

Photos taken at the conference are posted on [Flickr](#).

**Next year's conference will be held May 28-31, 2013, at the Cosmopolitan Hotel in Las Vegas, Nevada, USA.**

I think you will find it to be an amazing venue and I hope to see you there.

Best,



David McCann  
General Chair, 62nd Electronic Components and Technology Conference  
GLOBALFOUNDRIES

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